

74ABT373 Octal Transparent Latch with 3-STATE Outputs

Features

- 3-STATE outputs for bus interfacing
- Output sink capability of 64mA, source capability of 32mA
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Output switching specified for both 50pF and 250pF loads
- Guaranteed simultaneous switching, noise level and dynamic threshold performance
- Guaranteed latchup protection

Ordering Information

- High-impedance, glitch-free bus loading during entire power up and power down
- Nondestructive, hot-insertion capability

General Description

The ABT373 consists of eight latches with 3-STATE outputs for bus organized system applications. The flipflops appear transparent to the data when Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup times is latched. Data appears on the bus when the Output Enable (\overline{OE}) is LOW. When \overline{OE} is HIGH the bus output is in the high impedance state.

| Order Number | Package Number | Package Description | | | |
|--------------|-------------------|---|--|--|--|
| 74ABT373CSC | M20B | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide | | | |
| 74ABT373CSJ | M20D | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide | | | |
| 74ABT373CMSA | MSA20 | 20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide | | | |
| 74ABT373CMTC | MTC20 | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide | | | |

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number. Pb-Free package per JEDEC J-STD-020B.

Connection Diagram



Pin Descriptions

| Pin Names | Description |
|--------------------------------|----------------------------------|
| D ₀ D ₇ | Data Inputs |
| LE | Latch Enable Input (Active HIGH) |
| ŌĒ | Output Enable Input (Active LOW) |
| O ₀ –O ₇ | 3-STATE Latch Outputs |

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Functional Description

The ABT373 contains eight D-type latches with 3-STATE output buffers. When the Latch Enable (LE) input is HIGH, data on the D_n inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW, the latches store the information that was present on the D inputs at setup time preceding the HIGH-to-LOW transition of LE. The 3-STATE buffers are controlled by the Output Enable (\overline{OE}) input. When \overline{OE} is LOW, the buffers are in the bi-state mode. When \overline{OE} is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches.

Truth Table

| | Inputs | Output | |
|----|--------|----------------|----------------------------|
| LE | ŌE | D _n | O _n |
| Н | L | Н | Н |
| Н | L | L | L |
| L | L | Х | O _n (no change) |
| Х | Н | Х | Z |

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = HIGH Impedance State



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Rating |
|------------------|---|-------------------------------|
| T _{STG} | Storage Temperature | –65°C to +150°C |
| T _A | Ambient Temperature Under Bias | –55°C to +125°C |
| TJ | Junction Temperature Under Bias | –55°C to +150°C |
| V _{CC} | V _{CC} Pin Potential to Ground Pin | –0.5V to +7.0V |
| V _{IN} | Input Voltage ⁽¹⁾ | –0.5V to +7.0V |
| I _{IN} | Input Current ⁽¹⁾ | -30mA to +5.0mA |
| Vo | Voltage Applied to Any Output | |
| | Disabled or Power-Off State | –0.5V to +5.5V |
| | HIGH State | –0.5V to V_{CC} |
| | Current Applied to Output in LOW State (Max.) | twice the rated I_{OL} (mA) |
| | DC Latchup Source Current Across Common Operating Range | |
| | OE Pin | –150mA |
| | Other Pins | –500mA |
| | Over Voltage Latchup (I/O) | 10V |

Note:

1. Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol | Parameter | Rating |
|-----------------------|------------------------------|----------------|
| T _A | Free Air Ambient Temperature | –40°C to +85°C |
| V _{CC} | Supply Voltage | +4.5V to +5.5V |
| $\Delta V / \Delta t$ | Minimum Input Edge Rate | |
| | Data Input | 50mV/ns |
| | Enable Input | 20mV/ns |

| Symbol | Parameter V _{CC} Conditions | | Min. | Тур. | Max. | Units | | |
|------------------|--------------------------------------|-------------------------------------|--------|---|------|-------|------|------------|
| VIH | Input HIGH | Voltage | | Recognized HIGH Signal | 2.0 | | | V |
| V _{IL} | Input LOW | Voltage | | Recognized LOW Signal | | 0.8 | V | |
| V _{CD} | Input Clam | p Diode Voltage | Min. | $I_{IN} = -18 \text{mA}$ | | | -1.2 | V |
| V _{OH} | Output HIG | H Voltage | Min. | I _{OH} = -3mA | 2.5 | | | V |
| | | | | $I_{OH} = -32mA$ | 2.0 | | | |
| V _{OL} | Output LOV | V Voltage | Min. | $I_{OL} = 64 \text{mA}$ | | | 0.55 | V |
| I _{IH} | Input HIGH | Current | Max. | $V_{IN} = 2.7V^{(3)}$ | | | 1 | μA |
| | | | | $V_{IN} = V_{CC}$ | | | 1 | |
| I _{BVI} | Input HIGH Breakdown | | Max. | V _{IN} = 7.0V | | | 7 | μA |
| IIL | Input LOW | Current | Max. | $V_{IN} = 0.5V^{(3)}$ | | | -1 | μA |
| | | | | $V_{IN} = 0.0V$ | | | -1 | 1 |
| V_{ID} | Input Leakage Test | | 0.0 | I _{ID} = 1.9μA, All Other Pins Grounded | 4.75 | | | V |
| I _{OZH} | Output Lea | kage Current | 0–5.5V | $V_{OUT} = 2.7V, \overline{OE} = 2.0V$ | | | 10 | μA |
| I _{OZL} | Output Lea | kage Current | 0–5.5V | $V_{OUT} = 0.5V, \overline{OE} = 2.0V$ | | | -10 | μA |
| I _{OS} | Output Sho | ort-Circuit Current | Max. | $V_{OUT} = 0.0V$ | -100 | | -275 | mA |
| I _{CEX} | Output HIG | H Leakage Current | Max. | $V_{OUT} = V_{CC}$ | | | 50 | μA |
| I _{ZZ} | Bus Draina | ge Test | 0.0 | V _{OUT} = 5.5V, All Others GND | | | 100 | μA |
| I _{CCH} | Power Sup | ply Current | Max. | All Outputs HIGH | | | 50 | μA |
| I _{CCL} | Power Sup | ply Current | Max. | All Outputs LOW | | | 30 | mA |
| I _{CCZ} | Power Sup | ply Current | Max. | $\overline{OE} = V_{CC}$, All Others at V_{CC} or Ground | | | 50 | μA |
| I _{CCT} | Additional | Outputs Enabled | Max. | $V_{I} = V_{CC} - 2.1V$ | | | 2.5 | mA |
| | I _{CC} /Input | Outputs 3-STATE | - | Enable Input $V_I = V_{CC} - 2.1V$ | | | 2.5 | mA |
| | | Outputs 3-STATE | | Data Input $V_I = V_{CC} - 2.1V$, All Others at V_{CC} or Ground | | | 2.5 | mA |
| I _{CCD} | Dynamic I _C | _C No Load ⁽³⁾ | Max. | Outputs OPEN, LE = V_{CC} , $\overline{OE} = GND^{(2)}$, One-Bit Toggling, 50% Duty Cycle | | | 0.12 | mA/ MHz |

Notes:

2. For 8-bit toggling, $I_{CCD} < 0.8 \text{mA/MHz}.$

3. Guaranteed, but not tested.

DC Electrical Characteristics

SOIC package.

| | | | Conditions | | | | |
|------------------|---|-----------------|---------------------------------|------|------|------|-------|
| Symbol | Parameter | V _{cc} | $C_L = 50 pF, R_L = 500 \Omega$ | Min. | Тур. | Max. | Units |
| V _{OLP} | Quiet Output Maximum Dynamic V _{OL} | 5.0 | $T_A = 25^{\circ}C^{(4)}$ | | 0.4 | 0.8 | V |
| V _{OLV} | Quiet Output Minimum Dynamic V _{OL} | 5.0 | $T_A = 25^{\circ}C^{(4)}$ | -1.2 | -0.8 | | V |
| V _{OHV} | Minimum HIGH Level Dynamic Output Voltage | 5.0 | $T_A = 25^{\circ}C^{(5)}$ | 2.5 | 3.0 | | V |
| V _{IHD} | Minimum HIGH Level Dynamic Input Voltage | 5.0 | $T_A = 25^{\circ}C^{(6)}$ | 2.0 | 1.7 | | V |
| V _{ILD} | Maximum LOW Level Dynamic Input Voltage | 5.0 | $T_A = 25^{\circ}C^{(6)}$ | | 0.9 | 0.6 | V |

Notes:

4. Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output at Low. Guaranteed, but not tested.

5. Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

 Max number of data inputs (n) switching. n – 1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{IHD}). Guaranteed, but not tested.

AC Electrical Characteristics

SOIC and SSOP package.

| | | $\begin{array}{l} T_A=+25^\circ C,\\ V_{CC}=+5.0V,\\ C_L=50pF \end{array}$ | | $ \begin{array}{l} {\sf T}_{\sf A} = -55^{\circ}{\rm C} \ to \ +125^{\circ}{\rm C}, \\ {\sf V}_{\sf CC} = 4.5{\sf V} \ to \ 5.5{\sf V}, \\ {\sf C}_{\sf L} = 50{\sf p}{\sf F} \end{array} $ | | $ \begin{array}{c} {\sf T}_{\sf A} = -40^{\circ}{\rm C} \mbox{ to } +85^{\circ}{\rm C}, \\ {\sf V}_{\sf CC} = 4.5{\sf V} \mbox{ to } 5.5{\sf V}, \\ {\sf C}_{\sf L} = 50{\sf p}{\sf F} \end{array} $ | | | |
|------------------|----------------------------------|--|------|---|------|--|------|------|-------|
| Symbol | Parameter | Min. | Тур. | Max. | Min. | Max. | Min. | Max. | Units |
| t _{PLH} | Propagation Delay | 1.9 | 2.7 | 4.5 | 1.0 | 6.8 | 1.9 | 4.5 | ns |
| t _{PHL} | D _n to O _n | 1.9 | 2.8 | 4.5 | 1.0 | 7.0 | 1.9 | 4.5 | |
| t _{PLH} | Propagation Delay | 2.0 | 3.1 | 5.0 | 1.0 | 7.7 | 2.0 | 5.0 | ns |
| t _{PHL} | LE to O _n | 2.0 | 3.0 | 5.0 | 1.5 | 7.7 | 2.0 | 5.0 | |
| t _{PZH} | Output Enable Time | 1.5 | 3.1 | 5.3 | 1.0 | 6.7 | 1.5 | 5.3 | ns |
| t _{PZL} | | 1.5 | 3.1 | 5.3 | 1.5 | 7.2 | 1.5 | 5.3 | |
| t _{PHZ} | Output Disable Time | 2.0 | 3.6 | 5.4 | 1.7 | 8.0 | 2.0 | 5.4 | ns |
| t _{PLZ} | | 2.0 | 3.4 | 5.4 | 1.0 | 7.0 | 2.0 | 5.4 | |

AC Operating Requirements

SOIC and SSOP packages.

| | | $\begin{array}{l} T_{A}=+25^{\circ}C,\\ V_{CC}=+5.0V,\\ C_{L}=50pF \end{array}$ | | $\label{eq:T_A} \begin{split} T_A &= -55^\circ C \text{ to } +125^\circ C,\\ V_{CC} &= 4.5 V \text{ to } 5.5 V,\\ C_L &= 50 \text{pF}, \end{split}$ | | $ \begin{array}{c} {\sf T}_{\sf A} = -40^{\circ}{\rm C} \ to \ +85^{\circ}{\rm C}, \\ {\sf V}_{\sf CC} = 4.5{\sf V} \ to \ 5.5{\sf V} \\ {\sf C}_{\sf L} = 50{\sf p}{\sf F} \end{array} $ | | | |
|---------------------|---------------------------|---|------|---|------|---|------|------|-------|
| Symbol | Parameter | Min. | Тур. | Max. | Min. | Max. | Min. | Max. | Units |
| f _{TOGGLE} | Max Toggle Frequency | | 100 | | 100 | | | | MHz |
| t _S (H) | Setup Time, HIGH or | 1.5 | | | 2.5 | | 1.5 | | ns |
| t _S (L) | LOW, D _n to LE | 1.5 | | | 2.5 | | 1.5 | | |
| t _H (H) | Hold Time, HIGH or | 1.0 | | | 2.5 | | 1.0 | | ns |
| t _H (L) | LOW, D _n to LE | 1.0 | | | 2.5 | | 1.0 | | |
| t _W (H) | Pulse Width, LE HIGH | 3.0 | | | 3.3 | | 3.0 | | ns |

Extended AC Electrical Characteristics

SOIC package.

| | | $ \begin{array}{l} T_{A} = -40^{\circ} C \ to \ +85^{\circ} C, \\ V_{CC} = 4.5 V \ to \ 5.5 V, \\ C_{L} = 50 p F, \\ 8 \ Outputs \\ Switching^{(7)} \end{array} $ | | $T_A = -40^{\circ}C$ $V_{CC} = 4.5$ $C_L = 2$ | C to +85°C, V to 5.5V, 50pF ⁽⁸⁾ | $T_{A} = -40^{\circ}C$ $V_{CC} = 4.5$ $C_{L} = 2$ 8 Ou Switc | | |
|------------------|----------------------------------|---|------|---|--|--|------|-------|
| Symbol | Parameter | Min. | Max. | Min. | Max. | Min. | Max. | Units |
| t _{PLH} | Propagation Delay, | 1.5 | 5.2 | 2.0 | 6.8 | 2.0 | 9.0 | ns |
| t _{PHL} | D _n to O _n | 1.5 | 5.2 | 2.0 | 6.8 | 2.0 | 9.0 | |
| t _{PLH} | Propagation Delay, | 1.5 | 5.5 | 2.0 | 7.5 | 2.0 | 9.5 | ns |
| t _{PHL} | LE to O _n | 1.5 | 5.5 | 2.0 | 7.5 | 2.0 | 9.5 | |
| t _{PZH} | Output Enable Time | 1.5 | 6.2 | 2.0 | 8.0 | 2.0 | 10.5 | ns |
| t _{PZL} | | 1.5 | 6.2 | 2.0 | 8.0 | 2.0 | 10.5 | |
| t _{PHZ} | Output Disable Time | 1.0 | 5.5 | (1 | 0) | (1 | 10) | ns |
| t _{PZL} | | 1.0 | 5.5 |] | | | | |

Notes:

- 7. This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).
- This specification is guaranteed but not tested. The limits represent propagation delay with 250pF load capacitors in place of the 50pF load capacitors in the standard AC load. This specification pertains to single output switching only.
- 9. This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250pF load capacitors in place of the 50pF load capacitors in the standard AC load.
- 10. The 3-STATE delay times are dominated by the RC network (500Ω, 250pF) on the output and has been excluded from the datasheet.

Skew

SOIC package.

| | | $T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C,$ $V_{CC} = 4.5V - 5.5V,$ $C_{L} = 50\text{pF},$ 8 Outputs Switching ⁽¹¹⁾ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C,$ $V_{CC} = 4.5V - 5.5V,$ $C_L = 250\text{pF},$ 8 Outputs Switching ⁽¹²⁾ | |
|-----------------------------------|---|---|---|-------|
| Symbol | Parameter | Max. | Max. | Units |
| t _{OSHL} ⁽¹³⁾ | Pin to Pin Skew, HL Transitions | 1.0 | 1.5 | ns |
| t _{OSLH} ⁽¹³⁾ | Pin to Pin Skew, LH Transitions | 1.0 | 1.5 | ns |
| t _{PS} ⁽¹⁵⁾ | Duty Cycle, LH–HL Skew | 1.4 | 3.5 | ns |
| t _{OST} ⁽¹³⁾ | Pin to Pin Skew, LH/HL Transitions | 1.5 | 3.9 | ns |
| t _{PV} ⁽¹⁴⁾ | Device to Device Skew, LH/HL Transitions | 2.0 | 4.0 | ns |

Notes:

11. This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50pF load capacitors in the standard AC load.

- 12. This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).
- 13. Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW (t_{OSHL}), LOW-to-HIGH (t_{OSLH}), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW (t_{OST}). This specification is guaranteed but not tested.
- 14. Propagation delay variation is for a given set of conditions (i.e., temperature and V_{CC}) from device to device. This specification is guaranteed but not tested.
- 15. This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested.

Capacitance

| Symbol | Parameter | Conditions T _A = 25°C | Тур. | Units |
|----------------------------------|--------------------|-------------------------------------|------|-------|
| C _{IN} | Input Capacitance | $V_{CC} = 0V$ | 5 | pF |
| C _{OUT} ⁽¹⁶⁾ | Output Capacitance | $V_{CC} = 5.0V$ | 9 | pF |

Note:

16. C_{OUT} is measured at frequency f = 1MHz, per MIL-STD-883, Method 3012.







| Amplitude | Rep. Rate | t _w | t _r | t _f |
|-----------|-----------|----------------|----------------|----------------|
| 3.0V | 1MHz | 500ns | 2.5ns | 2.5ns |







Figure 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions







Figure 6. 3-STATE Output HIGH and LOW Enable and Disable Times















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